A Product Line of
Diodes Incorporated

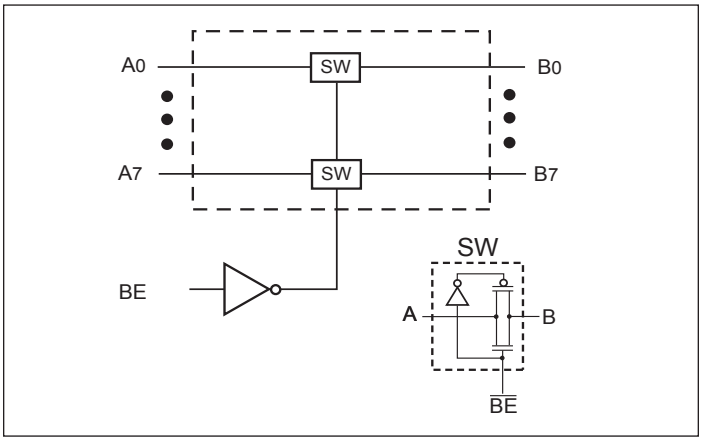
PI3B3245

3.3V, Hot Insertion, 8-Bit, 2-Port NanoSwitch

Description

The DIODES PI3B3245 is a 3.3V 8-bit, 2-port bus switch designed with a low On-Resistance (5Ω) allowing inputs to be connected directly to outputs. The bus switch creates no additional propagational delay or additional ground bounce noise. The switches are turned ON by the Bus Enable ($\overline{BE}$) input signal.

Block Diagram



Truth Table

Function	$\overline{BE}$	A0-7
Disconnect	H	Hi-Z
Connect	L	B0-7

Note:

H = High Voltage Level, L = Low Voltage Level, Hi-Z = High Impedance

Features

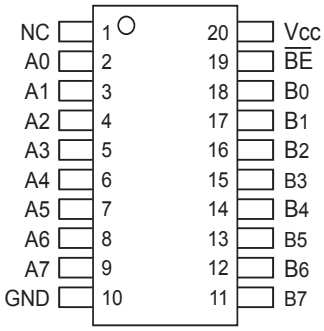
- Near-Zero Propagation Delay
- 5Ω Switches Connect Inputs to Outputs
- Fast Switching Speed: 4.5ns (Maximum)
- Ultra-Low Quiescent Power (0.2µA Typical)
  - Ideally suited for Notebook Applications
- TTL-compatible Control of Inputs Levels
- ESD Protection (2kV Human Body Model and 200V Machine Model)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. “Green” Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/
- Packaging (Pb-free & Green):
  - 20-pin, QSOP (Q)
  - 20-pin, TSSOP (L)
  - 20-pin, W-QFN (ZH)

Notes:

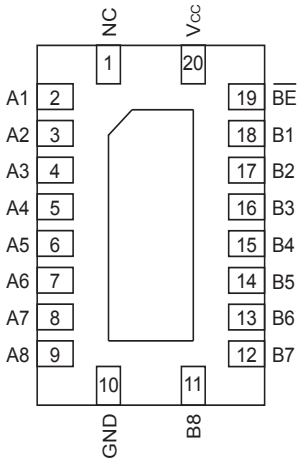
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated’s definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green” products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Pin Configuration

QSOP, TSSOP Package



W-QFN Package



Pin Description

Pin#	Pin Name		Description
	QSOP/TSSOP	W-QFN	
19	$\overline{BE}$	$\overline{BE}$	Bus Enable Input (Active LOW)
2, 3, 4, 5, 6, 7, 8, 9	A0-7	A1-8	Bus A Input/ Output
18, 17, 16, 15, 14, 13, 12, 11	B0-7	B1-8	Bus B Input/ Output
10	GND	GND	Ground (1)
20	V_{CC}	V_{CC}	Power
1	NC	NC	Not Connected

Note:

1. UQFN20 package die supply ground is connected to both GND pin and exposed center pad. GND pin must be connected to supply ground for proper device operation. For enhanced thermal, electrical, and board level performance, the exposed pad needs to be soldered to the board using a corresponding thermal pad on the board and for proper heat conduction through the board, thermal vias need to be incorporated in the PCB in the thermal pad region.

Absolute Maximum Ratings

(Above which useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	–65°C to +150°C
Ambient Temperature with Power Applied	–40°C to +85°C
Supply Voltage to Ground Potential	-0.5V to 4.6V
DC Input Voltage	-0.5V to 4.6V
DC Output Current	120mA
Power Dissipation	0.5W

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC Electrical Characteristics

Over the Operating Range, T_A = –40°C to +85°C, V_{CC} = 3.3V ±10%

Parameters	Description	Test Conditions[1]	Min.	Typ.[2]	Max.	Units
V_{IH}	Input HIGH Voltage	Guaranteed Logic HIGH Level	2.0			V
V_{IL}	Input LOW Voltage	Guaranteed Logic LOW Level	-0.5		0.8	V
I_{IH}	Input HIGH Current	V_{CC} = Max., V_{IN} = V_{CC}			±1	µA
I_{IL}	Input LOW Current	V_{CC} = Max., V_{IN} = GND			±1	µA
I_{OZH}	High Impedance Output Current	0 ≤ A_N, B_N ≤ V_{CC}			±1	µA
V_{IK}	Clamp Diode Voltage	V_{CC} = Min., I_{IN} = –18 mA			-1.2	V
R_{ON}	Switch On Resistance[3]	V_{CC} = Min., V_{IN} = 0.0V, I_{ON} = 48mA or 64mA		5	8	Ω
		V_{CC} = Min, V_{IN} = 2.4V, I_{ON} = 15mA		10	17	

Notes:

1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
2. Typical values are at V_{CC} = 3.3V, T_A = 25°C ambient and maximum loading.
3. Measured by the voltage drop between A and B pin at indicated current through the switch. ON resistance is determined by the lower of the voltages on the two (A,B) pins.

Capacitance

T_A = 25°C, f = 1 MHz

Parameters[1]	Description	Test Conditions	Typ.	Units
C_{IN}	Input Capacitance	V_{IN} = 0V	3.0	pF
C_{OFF}	A/B Capacitance, Switch Off	V_{IN} = 0V	8.0	pF
C_{ON}	A/B Capacitance, Switch On	V_{IN} = 0V	16.0	pF

Notes:

1. This parameter is determined by device characterization but is not production tested.

Power Supply Characteristics

Parameters	Description	Test Conditions[1]		Min.	Typ.[2]	Max.	Units
I_{CC}	Quiescent Power Supply Current	V_{CC} = Max.	V_{IN} = GND or V_{CC}		0.1	3.0	µA
ΔI_{CC}	Supply Current per Input HIGH	V_{CC} = Max.	V_{IN} = 3.0V[3]			750	µA

Notes:
1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device.
2. Typical values are at V_{CC} = 3.3V, +25°C ambient.
3. Per TTL driven input (control input only); A and B pins do not contribute to I_{CC}.

Switching Characteristics over Operating Range

Parameters	Description	Test Conditions	Com.		Units
			Min.	Max.	
t_{PLH} t_{PHL}	Propagation Delay[1,2] Ax to Bx, Bx to Ax	CL = 50 pF RL = 500Ω		0.25	ns
t_{PZH} t_{PZL}	Bus Enable Time $\overline{BE}$ to Ax or Bx		1.0	4.0	
t_{PHZ} t_{PLZ}	Bus Disable Time $\overline{BE}$ to Ax or Bx		1.0	4.5	

Notes:
1. This parameter is guaranteed but not tested on Propagation Delays.
2. The bus switch contributes no propagational delay other than the RC delay of the On-Resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.25 ns for 50 pF load. Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagational delay to the system. Propagational delay of the bus switch when used in a system is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

Applications Information

Logic Inputs

The logic control inputs can be driven up to +3.6V regardless of the supply voltage. For example, given a + 3.3V supply, A_N may be driven low to 0V and high to 3.6V. Driving B_N Rail-to-Rail® minimizes power consumption.

Power-Supply Sequencing and Hot-Plug Information

Proper power-supply sequencing is recommended for all CMOS devices. Always apply V_{CC} and GND before applying signals to input/output or control pins.

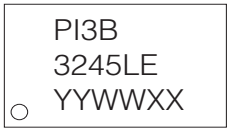
Rail-to-Rail is a registered trademark of Nippon Motorola, Ltd.

Part Marking

Q Package

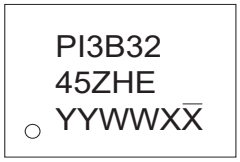
YY: Year
WW: Workweek
1st X: Assembly Site Code
2nd X: Fab Site Code
Bar above fab code means Cu wire
Without bar above fab code means Au wire

L Package



YY: Year
WW: Workweek
1st X: Assembly Code
2nd X: Fab Code

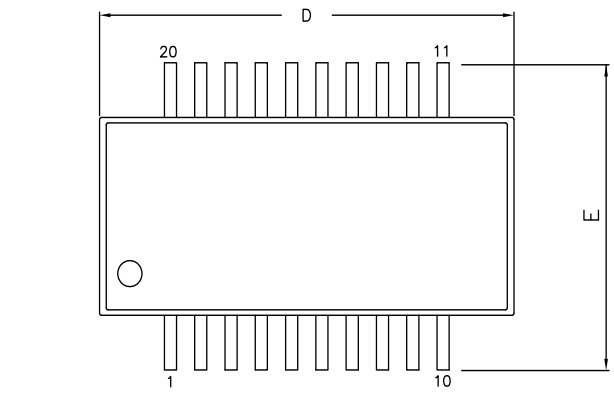
ZH Package

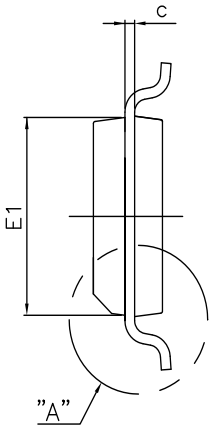


YY: Date Code (Year)
WW: Date Code (Workweek)
1st X: Assembly Code
2nd X: Fab Code
Bar above 2nd “X” means Cu wire

Packaging Mechanical

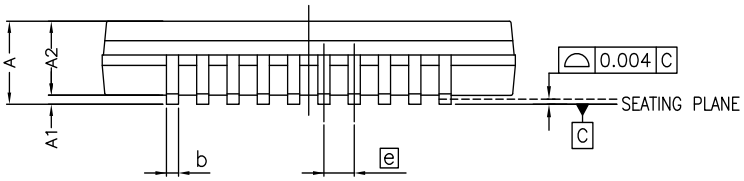
20-QSOP (Q)

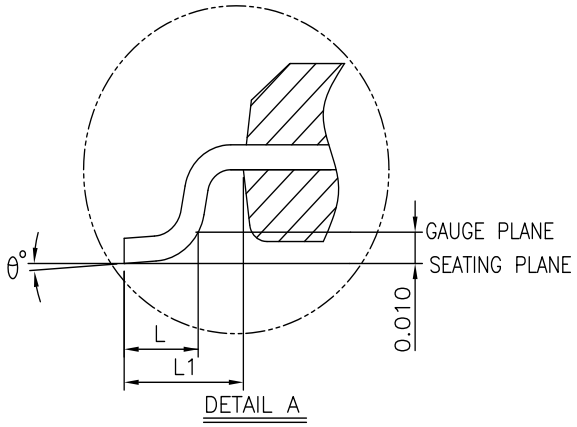




SYMBOLS	MIN.	NOM.	MAX.
A	–	–	0.069
A1	0.004	–	0.0098
A2	0.049	–	–
b	0.008	–	0.012
c	0.004	–	0.010
D	0.337	0.341	0.345
E	0.228	0.236	0.244
E1	0.150	0.154	0.158
e	0.025 BSC		
L	0.016	0.025	0.050
L1	0.041 REF		
θ°	0°	–	8°

UNIT : INCH





NOTES:
1. ALL DIMENSIONS IN INCH. ANGLES IN DEGREES.
2. JEDEC MO-137E
3. DIMENSIONS DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

16-0057

PERICOM Enabling Serial Connectivity

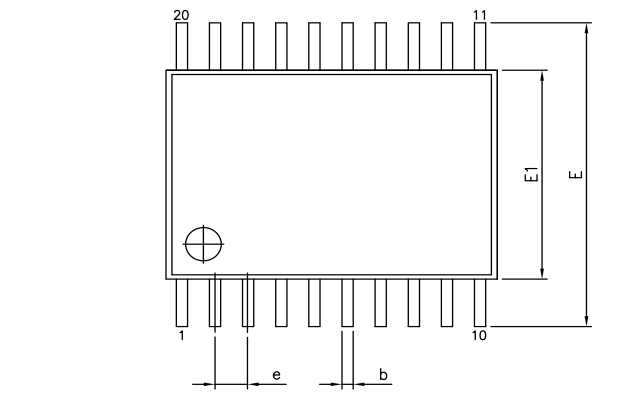
DATE: 03/24/16

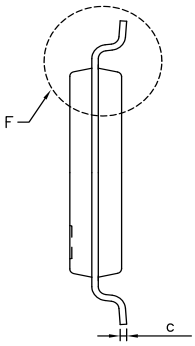
DESCRIPTION: 20-Pin, 150mil Wide QSOP

PACKAGE CODE: Q (Q20)

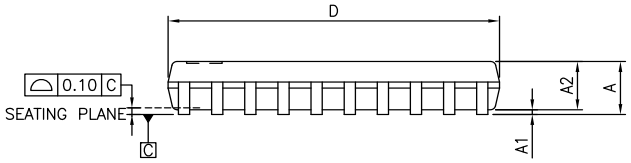
DOCUMENT CONTROL #: PD-1202 REVISION: I

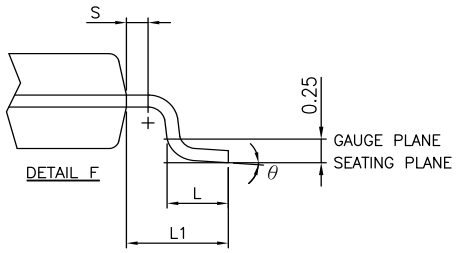
20-TSSOP (L)





SYMBOLS	MIN.	NOM.	MAX.
A	–	–	1.20
A1	0.05	–	0.15
A2	0.80	1.00	1.05
b	0.19	–	0.30
C	0.09	–	0.20
D	6.40	6.50	6.60
E1	4.30	4.40	4.50
E	6.20	6.40	6.60
e	0.65 BSC		
L1	1.00 REF		
L	0.45	0.60	0.75
S	0.20	–	–
θ	0°	–	8°





NOTES:
1. ALL DIMENSIONS IN MILLIMETERS. ANGLES IN DEGREES.
2. JEDEC MO–153F
3. DIMENSIONS DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

PERICOM Enabling Serial Connectivity

DATE: 03/31/16

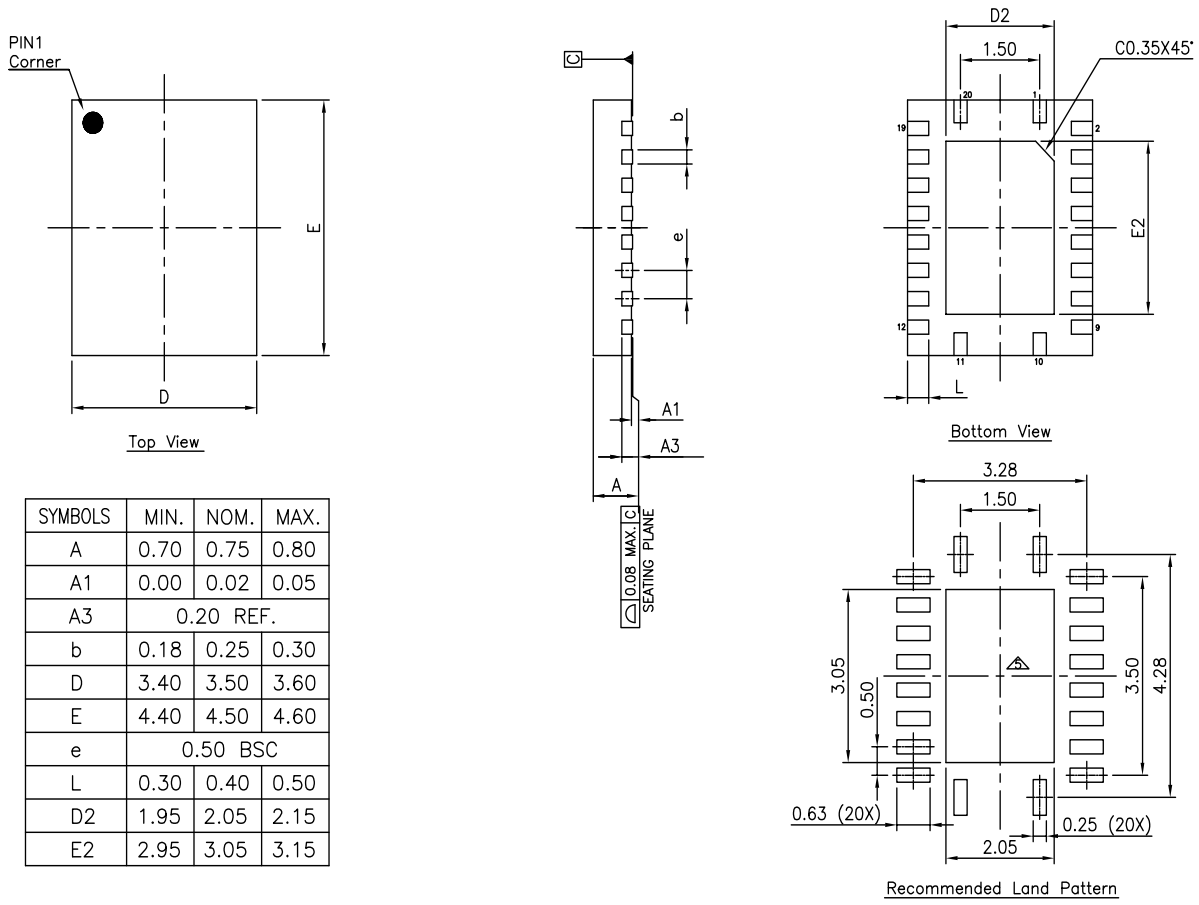
DESCRIPTION: 20-PIn, 173mII WIde TSSOP

PACKAGE CODE: L (L20)

DOCUMENT CONTROL #: PD-1311 **REVISION: G**

16-0074

20-W-QFN (ZH)



SYMBOLS	MIN.	NOM.	MAX.
A	0.70	0.75	0.80
A1	0.00	0.02	0.05
A3		0.20 REF.	
b	0.18	0.25	0.30
D	3.40	3.50	3.60
E	4.40	4.50	4.60
e		0.50 BSC	
L	0.30	0.40	0.50
D2	1.95	2.05	2.15
E2	2.95	3.05	3.15

NOTE :
1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
2. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
3. REFER JEDEC MO-241.
4. RECOMMENDED LAND PATTERN IS FOR REFERENCE ONLY.
5. THERMAL PAD SOLDERING AREA (MESH STENCIL DESIGN IS RECOMMENDED)

DATE: 05/31/23

DESCRIPTION: W-QFN3545-20

PACKAGE CODE: ZH (ZH20)

DOCUMENT CONTROL #: PD-2032 REVISION: C

For latest package info.

please check: http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/

Ordering Information

Ordering Code	Package Code	Description
PI3B3245QEX	Q	20-pin, 150mil Wide (QSOP)
PI3B3245LEX	L	20-pin, 173mil Wide (TSSOP)
PI3B3245ZHEX	ZH	20-pin, W-QFN3545-20

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. E = Pb-free and Green
5. X suffix = Tape/Reel

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